

Applicant: Salman Akram
Docket No.: 11675.184.2

Applicant: Salman Akram

Docket No.: 11675.184.2

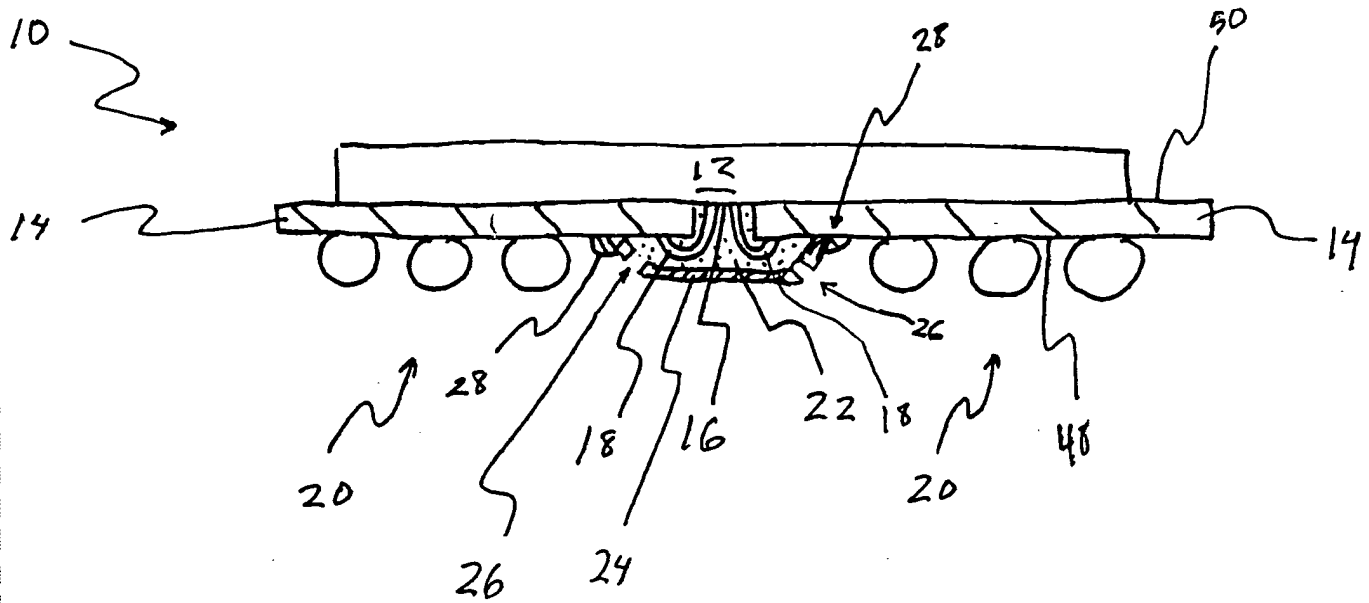


FIGURE 1

Applicant: Salman Akram
Docket No.: 11675.184.2

FIGURE 2

Title: CHIP PACKAGE WITH GREASE
HEAT SINK
Applicant: Salman Akram
Docket No.: 11675.184.2

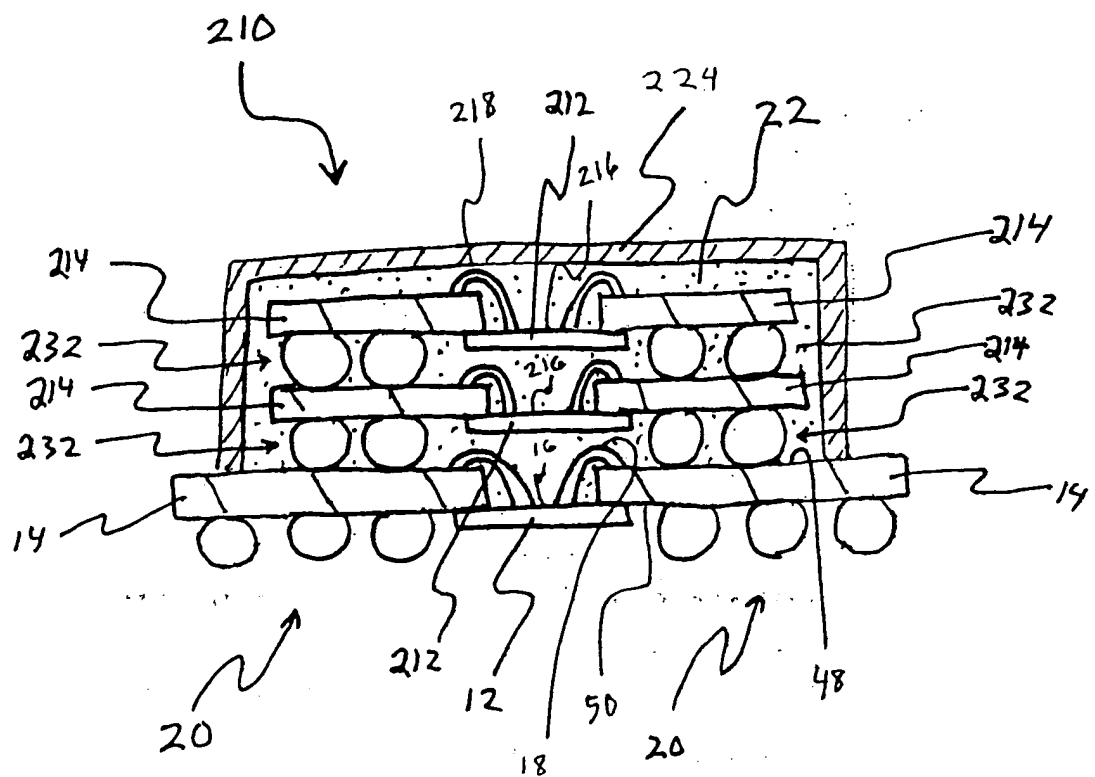


FIGURE 3

Applicant: Salman Akram
Docket No.: 11675.184.2

Docket No.: 11675.184.2

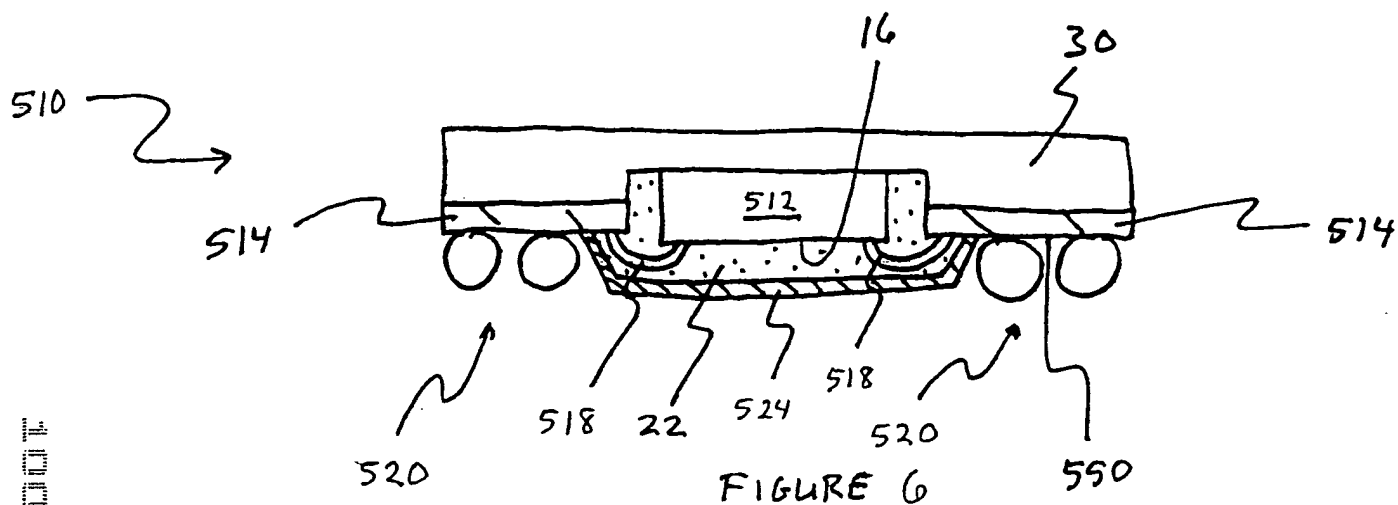


Applicant: Salman Akram
Docket No.: 11675.184.2

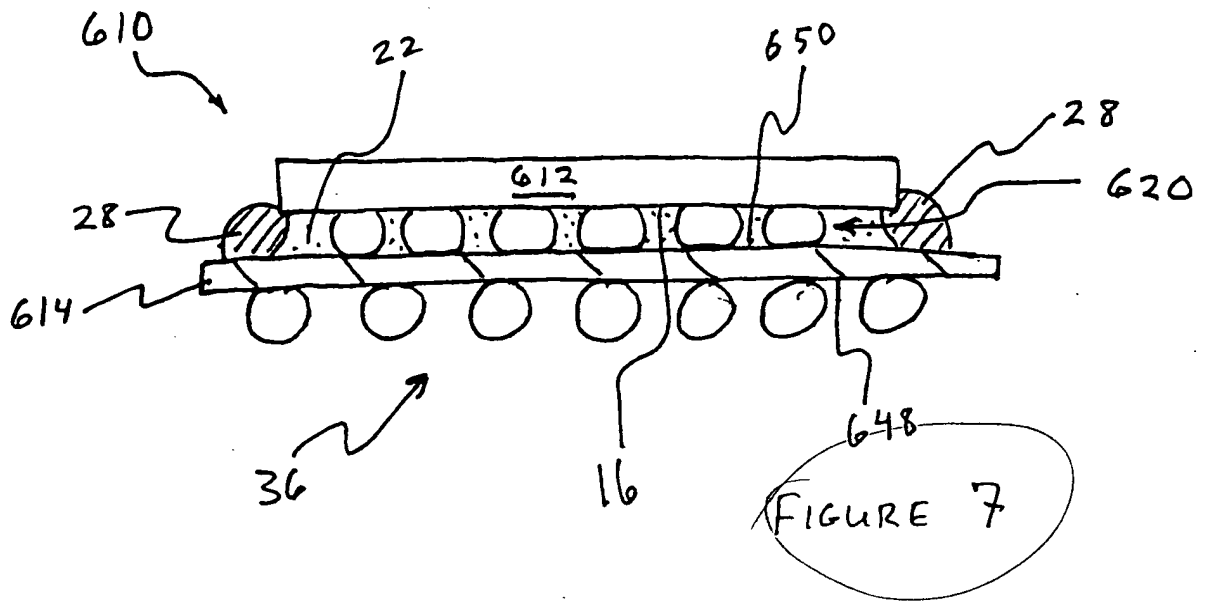


THE UNIVERSITY OF CHICAGO

Applicant: Salman Akram
Docket No.: 11675.184.2



Title: CHIP PACKAGE WITH GREASE
HEAT SINK
Applicant: Salman Akram
Docket No.: 11675.184.2



20250717 14:08:00

Title: CHIP PACKAGE WITH GREASE
HEAT SINK
Applicant: Salman Akram
Docket No.: 11675.184.2

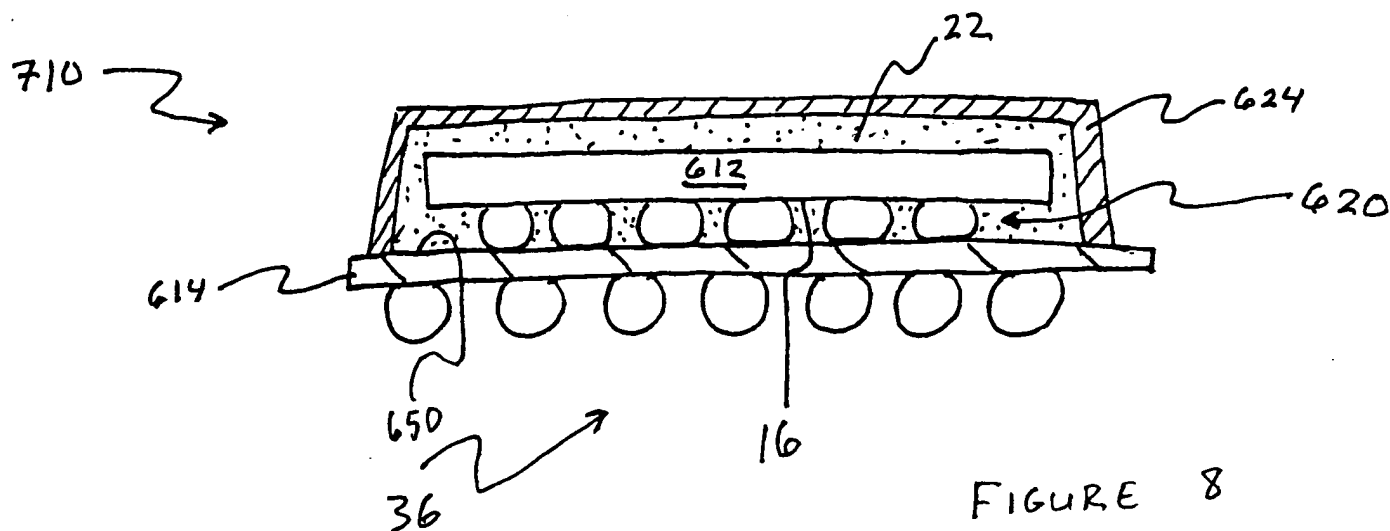


FIGURE 8

www.researchgate.net

Title: CHIP PACKAGE WITH GREASE
HEAT SINK

Applicant: Salman Akram

Docket No.: 11675.184.2

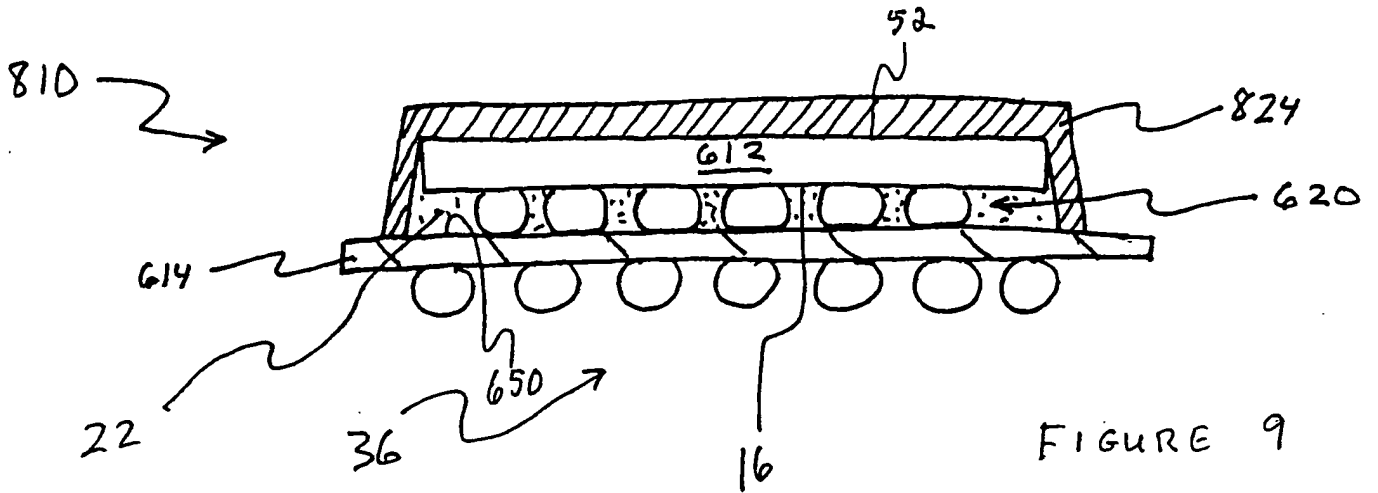


FIGURE 9

Accepted for Patent

Title: CHIP PACKAGE WITH GREASE
HEAT SINK

Applicant: Salman Akram

Docket No.: 11675.184.2

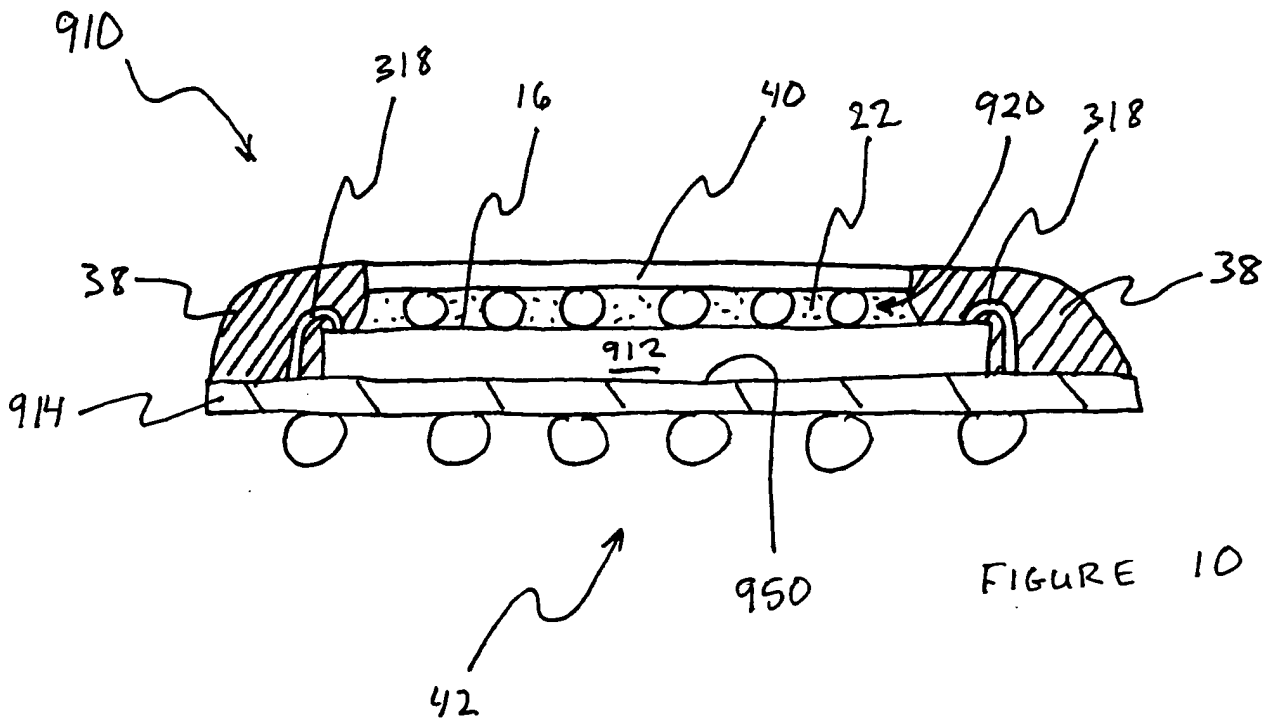


FIGURE 10

Title: CHIP PACKAGE WITH GREASE
HEAT SINK

Applicant: Salman Akram
Docket No.: 11675.184.2

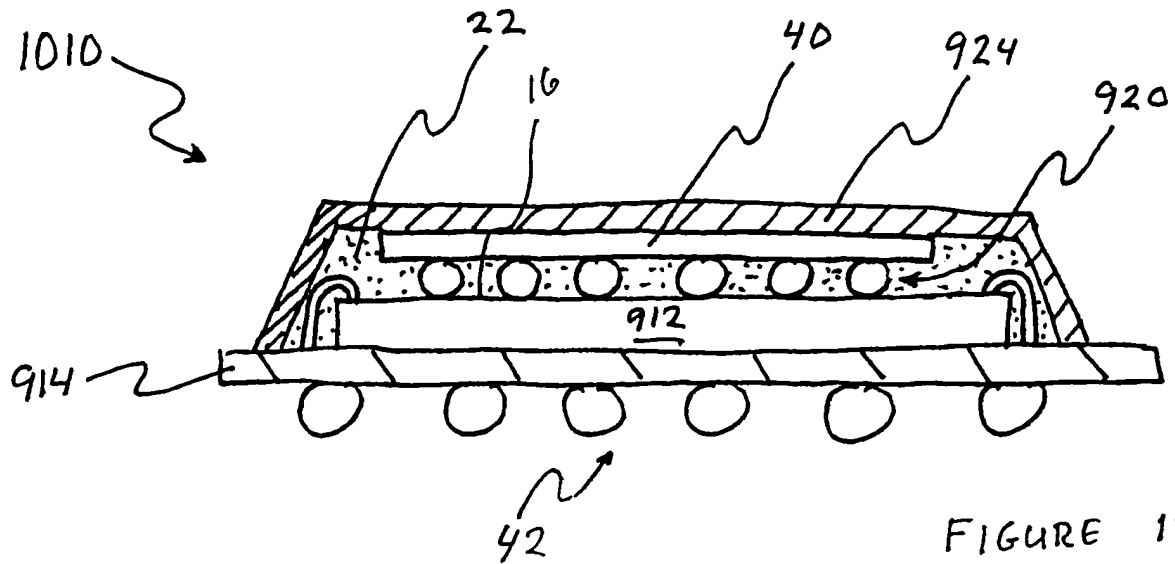


FIGURE 11

2025-03-20 14:00:00

Applicant: Salman Akram
Docket No.: 11675.184.2

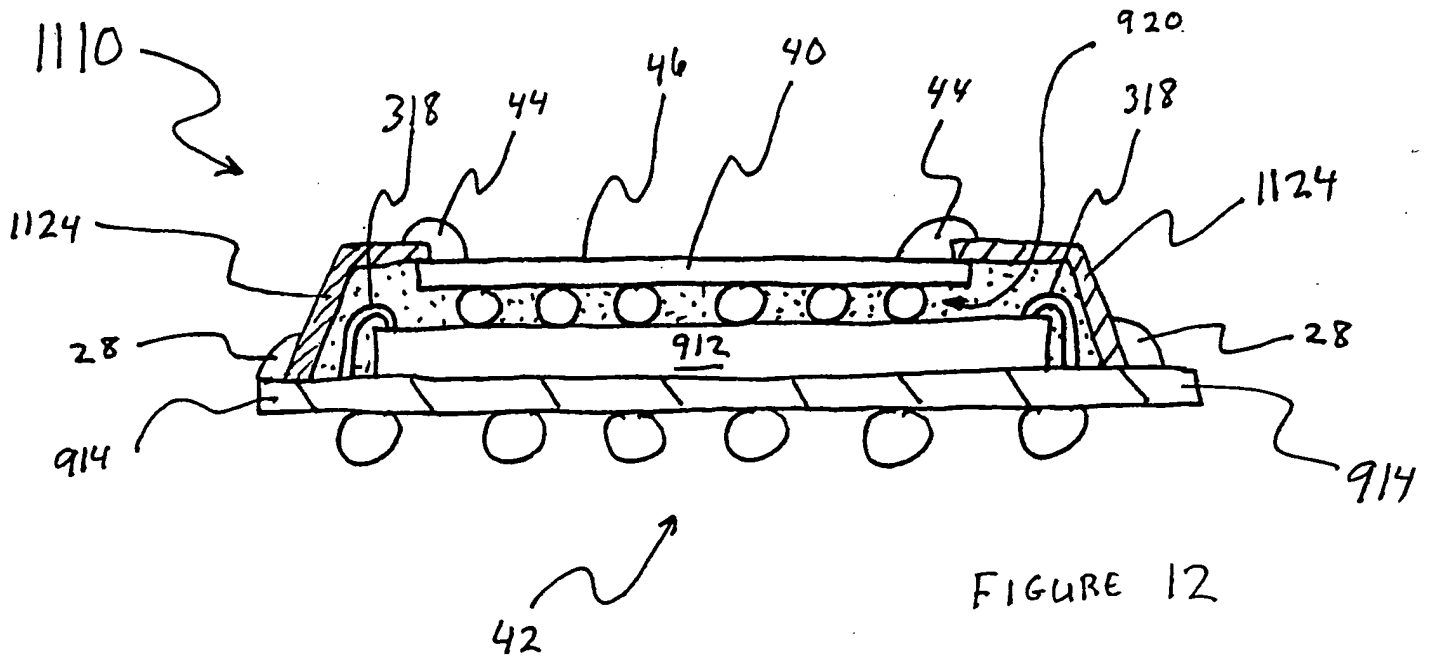


FIGURE 12